Amendments to the Claims

This listing of claims replaces all prior versions, and listings, of claims in the application.

Listing of claims:

1. (Currently amended) A UV-curable resin composition for bonding substrates of an optical disk, one or both of which have a total reflection film or a translucent reflection film comprising silver or a silver alloy, characterized in that the UV-curable resin composition comprises, as essential components, an epoxy (meth)acrylate (A), 2,2-dimethoxy-1,2-diphenylethan-1-one and a mono- to trifunctional (meth)acrylate monomer (E) other than (A), a monofunctional (meth)acrylate compound (C) containing a hydroxyl group, and a (meth)acrylate phosphate compound (D)~~, provided that the composition does not comprise a urethane (meth)acrylate~~.

2. (Original) The UV-curable resin composition according to claim 1, wherein the mono- to trifunctional (meth)acrylate monomer (E) is dicyclopentanyl di(meth)acrylate.

3. (Original) The UV-curable resin composition according to claim 1, wherein the mono- to trifunctional (meth)acrylate monomer (E) is hydroxypivalic acid neopentyl glycol di(meth)acrylate.

4. (Cancelled)

5. (Cancelled)

6. (Currently amended) The UV-curable resin composition according to any one of claims 1 to 3 ~~5~~, which has an electrical

resistivity of 1000 MΩ·cm (MΩ=10^6Ω) or less at 25°C.

7. (Currently amended) A bonded optical disk in which two disk substrates are allowed to adhere with a UV-curable resin composition according to any one of claims 1 to ~~6~~ 3.

8. (Cancelled)

9. (New) A bonded optical disk in which two disk substrates are allowed to adhere with a UV-curable resin composition according to claim 6.